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Application No.: 10/055,560

SEP 14 2005

Docket No.: JCLA8532-R

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner: MITCHELL, JAMES M

Group Art Unit: 2813

In re PATENT APPLICATION of

Applicants : LIN ET AL.

Serial No. : 10/055,560

Filed : January 22, 2002

For : INTEGRATED CHIP PACKAGE  
STRUCTURE USING METAL  
SUBSTRATE AND METHOD OF  
MANUFACTURING THE SAMEAMENDMENTPRELIMINARY AMENDMENT

MAIL STOP AF

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir,

The Office Action mailed June 14, 2005 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.

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